

10-06-2003



EET

102568039

mark Office:
Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

[FAMILY NAME (ALL CAPS), Given Name]

CHENG, S. J.

LIU, An-Hong

WANG, Yeong-Her

TSENG, Yuan-Ping

LEE, Y.J.

Additional name(s) of conveying party(ies) attached?

☐ YES ☒ NO

2. Name and address of receiving party(ies)

Name: CHIP MOS TECHNOLOGIES (BERMUDA) LTD.

Street Address: Cedar House, 41 Cedar Avenue

City: Hamilton

State:

ZIP:

Country: Bermuda

Postal Code: HM 12

Additional name(s) & address(es) attached? ☒ YES ☐ NO03970 U.S. PTO
10/6/1735

09/29/03

3. Nature of conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ Other:Execution Date: September 9, 2003; September 5, 2003;
September 10, 2003; September 9, 2003;
September 12, 2003, respectively

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: September 9, 2003; September 5, 2003;
September 10, 2003;
September 9, 2003;
September 12, 2003,
respectively

10671735

A. Patent Application No(s).

NEW

B. Patent No.(s).

Additional numbers attached? ☐ YES ☒ NO

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: BIRCH, STEWART, KOLASCH & BIRCH, LLP

Street Address: P.O. BOX 747

City: FALLS CHURCH State: VA ZIP: 22040-0747

Country: USA

6. Total No. of applications/patents involved: One (1)

7. Total fee (37 C.F.R. § 3.41): \$40.00

☒ Enclosed☒ Authorized to be charged to deposit account,
if no fee attached.

8. Deposit account number: 02-2448

(Attach triplicate copy of this page
if paying by deposit account)

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9. Statement and signature.

Joe McKinney Muncy, #32,334

Name of Person Signing/Reg. No.

Signature

September 29, 2003

Date

Total number of pages including cover sheet, attachments, and document: Four (4)

10/01/2003 GWORDOF1 00000101 10671735

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KM/tmr

(Rev. 04/30/03)

PATENT
REEL: 014544 FRAME: 0523

Attachment to
RECORDATION FORM COVER SHEET

03970 U.S. PTO
10/671735

09/29/03

Continuation of Box 1--Name of conveying party(ies):

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Continuation of Box 2--Name and address of receiving party(ies):

CHIPMOS TECHNOLOGIES INC.
No. 1 R&D Rd. 1, Science-Based Industrial Park
Hsinchu
Taiwan
R.O.C.

Continuation of Box 4--Application number(s) or patent number(s):

BIRCH, STEWART, KOLASCH & BIRCH, LLP

UNITED STATES PATENT RIGHTS, OR
UNITED STATES PLUS ALL FOREIGN PATENT RIGHTS

ASSIGNMENT

Application No. NEW

Filed September 29, 2003

Insert Name(s)
of Inventor(s)

*****(Given Name FAMILY NAME (ALL CAPS))*****

WHEREAS, S. J. Cheng An-Hong Liu
Yeong-Her Wang Yuan-Ping Tseng Y.J. Lee

(hereinafter designated as the undersigned) has (have) invented certain new and useful improvements in

Insert Title
of Invention

METHOD FOR FABRICATING ANISOTROPIC CONDUCTIVE SUBSTRATE

for which an application for Letters Patent of the United States of America has been executed by the undersigned (except in the case of a provisional application).

Insert Date
of Signing of
Application

on September 9, 2003; September 5, 2003; September 10, 2003; and
September 9, 2003; September 12, 2003, respectively

Insert Name
of Assignee

WHEREAS, ChipMOS Technologies (Bermuda) Ltd.
ChipMOS TECHNOLOGIES INC.

Insert Address
of Assignee

of Cedar House, 41 Cedar Avenue, Hamilton HM 12, Bermuda
No.1. R&D Rd.1, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent(s) that may be granted therefor in the United States of America and

CHECK BOX
IF APPROPRIATE

☐ in any foreign countries.

NOW, THEREFORE, in consideration of the sum of Ten Dollars (\$10.00) to the undersigned in hand paid, the receipt of which is hereby acknowledged, and other good and valuable consideration, the undersigned has (have) sold, assigned and transferred, and by these presents does sell, assign and transfer unto said Assignee the full and exclusive right to the said invention in the United States of America, its territories, dependencies and possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be granted therefor in the United States of America, its territories, dependencies and possessions, and if the box above is designated, in any and all foreign countries;

and to any and all divisions, reissues, continuations, conversions and extensions thereof for the full term or terms for which the same may be granted.

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional, conversion or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree (s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division, conversion or reissue thereof or Letter Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States of America patent(s) or a grant of a valid United States of America and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patents resulting from said application or any continuing, divisional conversion or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of Birch, Stewart, Kolasch & Birch, LLP the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

The undersigned hereby covenant(s) that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date 09/09/2003

Name of Inventor

(signature) S. J. Cheng

Date 09/05/2003

Name of Inventor

(signature) An-Hong Liu

Date 09/16/2003

Name of Inventor

(signature) Yeong-Her Wang

Date 9/09/2003

Name of Inventor

(signature) Yuan-Ping Tseng

Date 09/12/2003

Name of Inventor

(signature) Y.J. Lee

Date _____

Name of Inventor

(signature)